

SEMICONDUCTOR®

4-PIN FULL PITCH MINI-FLAT PACKAGE RANDOM PHASE TRIAC DRIVER OUTPUT OPTOCOUPLERS

FODM3051

FODM3052

FODM3053

DESCRIPTION

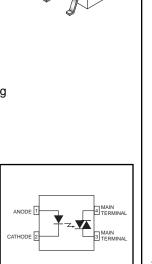
The FODM305X series consists of a galium arsenide diode driving a silicon bilateral switch housed in a compact 4-pin mini-flat package. The lead pitch is 2.54 mm. The FODM305X series isolates low voltage logic from 115 and 240 Vac lines to provide random phase control of high current triacs or thyristors. It also features greatly enhanced static dv/dt capability to ensure stable switching performance of inductive loads.

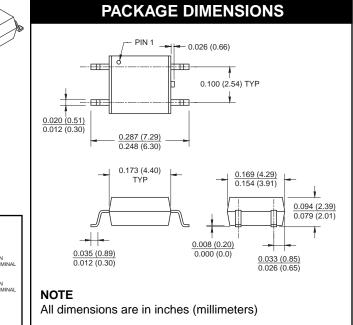
FEATURES

- Compact 4-pin surface mount package (2.4 mm maximum standoff height)
- Peak blocking voltage 600V
- Guaranteed static dv/dt of 1000 V/µs
- Available in tape and reel quantities of 500 and 2500.
- Applicable to Infrared Ray reflow (230°C max, 30 seconds.)
- BSI, CSA and VDE certifications pending
- UL (File# E90700) certified

APPLICATIONS

- Solenoid/valve controls
- Interfacing microprocessors to 115 and 240 Vac peripherals
- Temperature controls
- Solid state relays
- Lamp ballast
- Static AC power switch
- Motor control
- Incandescent lamp dimmers





| Parameter | Symbol | Value | Units |
|--|----------------------|-------------|----------|
| TOTAL PACKAGE | | | |
| Storage Temperature | T _{STG} | -40 to +125 | °C |
| Junction Temperature | TJ | 125 | °C |
| Operating Temperature | T _{OPR} | -40 to +85 | °C |
| EMITTER | | | |
| Continuous Forward Current | I _{F (avg)} | 60 | mA |
| Peak Forward Current (1 µs pulse, 300 pps.) | I _{F (pk)} | 1 | A |
| Reverse Input Voltage | V _R | 3 | V |
| Power Dissipation (No derating required over operating temp. range) | PD | 100 | mW |
| DETECTOR On-State RMS Current | I _{T(RMS)} | 70 | mA (RMS) |
| Off-State Output Terminal Voltage | V _{DRM} | 600 | V |
| Power Dissipation (No derating required over operating temp. range) | PD | 250 | mW |



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| ELECTRICAL CHARACTERISTICS (T _A = 25°C Unless otherwise specified) | | | | | | | |
|--|--|------------------|--------|------|------|-----|------|
| INDIVIDUAL COMPONENT CHARACTERISTICS | | | | | | | |
| Parameter | Test Conditions | Symbol | Device | Min | Тур* | Max | Unit |
| EMITTER | | | | | | | |
| Input Forward Voltage | I _F = 10 mA | V _F | All | | 1.20 | 1.5 | V |
| Reverse Leakage Current | V _R = 3 V | I _R | All | | 0.01 | 100 | μA |
| DETECTOR | | | | | | | |
| Peak Blocking Current Either Direction | V _{DRM} = 600V, I _F = 0 (note 1) | I _{DRM} | All | | 3 | 100 | nA |
| Peak On-State Voltage Either Direction | I _{TM} = 100mA peak | V _{TM} | All | | 2.0 | 2.5 | V |
| Critical Rate of Rise of Off-State Voltage | I _F = 0 (Figure 8, note 2) | dV/dt | All | 1000 | | | V/µs |

| TRANSFER CHARACTERISTICS (T _A = 25°C Unless otherwise specified) | | | | | | | |
|--|--|-----------------|----------|-----|------|-----|------|
| DC Characteristics | Test Conditions | Symbol | Device | Min | Тур* | Max | Unit |
| LED Trigger Current | Main Terminal Voltage = 3V (note 3) | I _{FT} | FODM3051 | | | 15 | mA |
| | | | FODM3052 | | | 10 | |
| | | | FODM3053 | | | 5 | |
| Holding Current, Either Direc- tion | | Ι _Η | All | | 300 | | μA |

| ISOLATION CHARACTERISTICS (T _A = 25°C Unless otherwise specified) | | | | | | | |
|---|-----------------|--------|--------|-----|------|-----|------|
| Characteristic | Test Conditions | Symbol | Device | Min | Тур* | Max | Unit |
| Steady State Isolation Voltage t = 1 Minute V _{ISO} All 3750 V(RMS) | | | | | | | |

* All typicals at $T_A = 25^{\circ}C$

Note

1. Test voltage must be applied within dv/dt rating.

2. This is static dv/dt. See Figure 1 for test circuit. Commutating dv/dt is function of the load-driving thyristor(s) only.

 All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (15 mA for FODM3051, 10 mA for FODM3052, 5 mA for FODM3053) and absolute max I_F (60 mA).

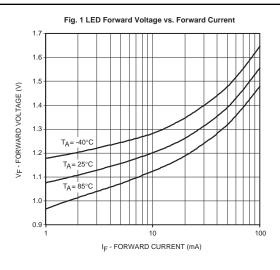


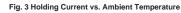
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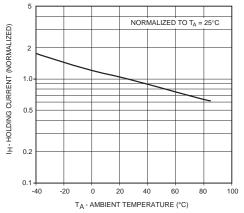
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TYPICAL PERFORMANCE CURVES









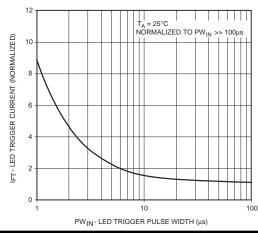
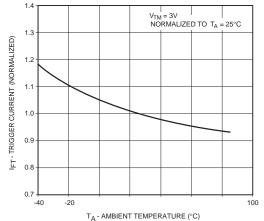
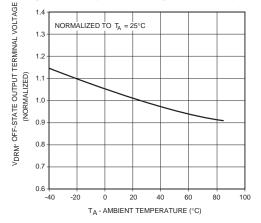


Fig. 2 Leakage Current vs. Ambient Temperature 1000-VDRM = 600V IDRM - LEAKAGE CURRENT (nA) 100 10 0.1 -40 -20 0 20 40 60 80 100 TA - AMBIENT TEMPERATURE (°C)

Fig. 4 Trigger Current vs. Ambient Temperature









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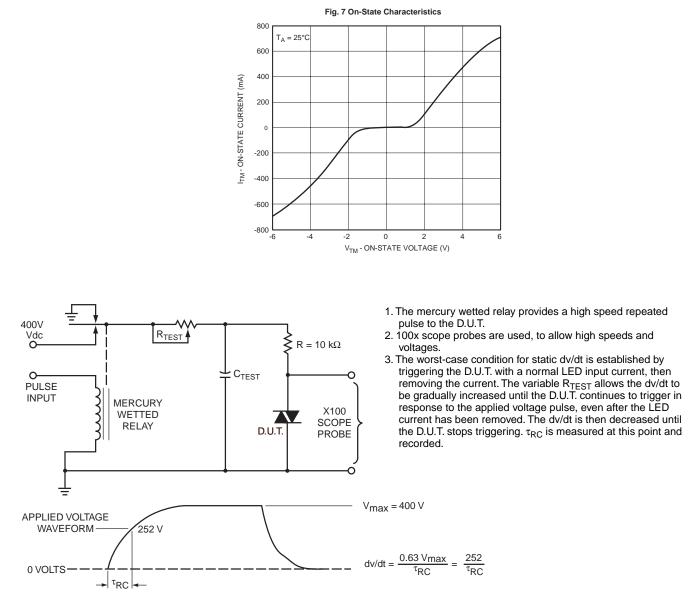


Figure 8. Static dv/dt Test Circuit



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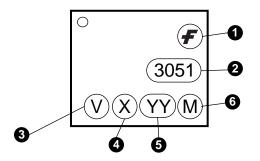
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ORDERING INFORMATION

| Option | Description | | |
|--------|--|--|--|
| V | VDE Approved | | |
| R1 | Tape and Reel (500 units) | | |
| R2 | Tape and Reel (2500 units) | | |
| R3 | Tape and Reel (500 units; unit 180° rotated) | | |
| R4 | Tape and Reel (2500 units; unit 180° rotated) | | |
| R1V | Tape and Reel (500 units) and VDE Approved | | |
| R2V | Tape and Reel (2500 units) and VDE Approved | | |
| R3V | Tape and Reel (500 units; unit 180° rotated) and VDE Approved | | |
| R4V | Tape and Reel (2500 units; unit 180° rotated) and VDE Approved | | |

MARKING INFORMATION



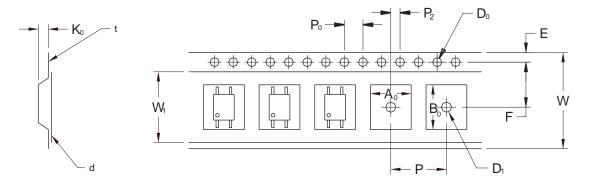
| Definitions | | | | |
|-------------|--|--|--|--|
| 1 | Fairchild logo | | | |
| 2 | Device number | | | |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) | | | |
| 4 | One digit year code | | | |
| 5 | Two digit work week ranging from '01' to '53' | | | |
| 6 | Assembly package code | | | |



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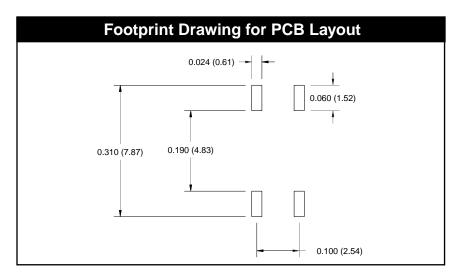
| | | | 2.54 Pitch |
|---------------------------------|------------------|-----------------|-----------------|
| Description | | Symbol | Dimensions (mm) |
| Tape Width | | W | 12.00±0.4 |
| Tape Thickness | | t | 0.30±0.20 |
| Sprocket Hole Pitch | | P₀ | 4.00±0.20 |
| Sprocket Hole Dia. | | Do | 1.55±0.20 |
| Sprocket Hole Location | | E | 1.75±0.20 |
| Pocket Location | | F | 5.50±0.20 |
| | | P ₂ | 2.00±0.20 |
| Pocket Pitch | Pocket Pitch | | 8.00±0.20 |
| Pocket Dimension | | A ₀ | 4.40±0.20 |
| | | B ₀ | 7.30±0.20 |
| | | | 2.30±0.20 |
| Pocket Hole Dia. | Pocket Hole Dia. | | 1.55±0.20 |
| Cover Tape Width | | VV ₁ | 9.20 |
| Cover Tape Thickness | | d | 0.065±0.02 |
| Max. Component Rotation or Tilt | | | 20° max |
| Devices Per Reel R1 | | | 500 |
| | R2 | | 2500 |
| Reel Diameter | R1 | | 178 mm (7") |
| | R2 | | 330 mm (13") |

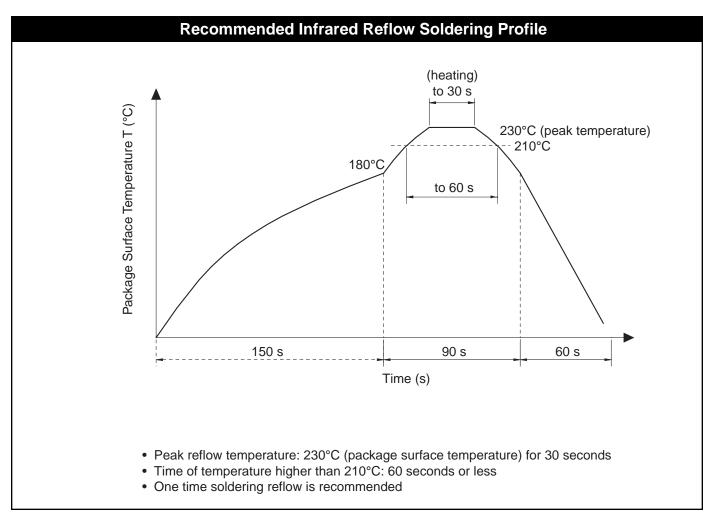


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4-PIN FULL PITCH MINI-FLAT PACKAGE RANDOM PHASE TRIAC DRIVER OUTPUT OPTOCOUPLERS

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